IEEE P802.11  
Wireless LANs

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| REVme May-July teleconference agenda | | | | |
| Date: 2022-06-23 | | | | |
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Abstract

This document contains the draft agenda for the TGme Task Group for May-July 2022 teleconference meetings.

R0: Initial draft, posted prior to the 2022-03-24 teleconference

R1: Updates based on initial posting.

R2: Further re-scheduling of agenda items.

R3: Updates with agenda changes during the May 27th teleconference

R4: Updates to the agenda based on the June 3rd teleconference.

R5: Updates to the agenda based on agenda requests after the June 3rd meeting.

R6: Updates to the agenda following the June 6th Meeting.

R7: Updates to the agenda based on meeting review and other agenda requests.

R8: Updates to the agenda based on meeting review and other agenda requests.

R9: Agenda changes prior to June 20 teleconference

R10: Further agenda updates prior to the June 24th telconference

# 2022 May-July Teleconference Agendas

TGme will hold teleconferences for the purpose of moving to initial LB.

See the TGme calendar entries at: <http://grouper.ieee.org/groups/802/11/>

**The draft agenda for the teleconferences is below:**

1.       Call to order, attendance (<https://imat.ieee.org/attendance> ), and patent and copyright policy

a.       **Patent Policy: Ways to inform IEEE:**

1. Cause an LOA to be submitted to the IEEE-SA ([patcom@ieee.org](mailto:patcom@ieee.org)); or
2. Provide the chair of this group with the identity of the holder(s) of any and all such claims as soon as possible; or
3. Speak up now and respond to this Call for Potentially Essential Patents

If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group and that are not already the subject of an Accepted Letter of Assurance, please respond at this time by providing relevant information to the WG Chair

b. **Copyright Policy:**

* + 1. By participating in this activity, you agree to comply with the IEEE Code of Ethics, all applicable laws, and all IEEE policies and procedures including, but not limited to, the IEEE SA Copyright Policy.

c.**Participation and policy related (including Patent and Copyright) slides: See p4-19 in** <https://mentor.ieee.org/802.11/dcn/22/11-22-0593-00-0000-2nd-vice-chair-report-may-2022.pptx>

d.**Agenda Approval**

2.       **Editor report** – Emily QI/Edward AU

3.       **Comment resolution and motions**

1. **Friday May 27, 2022 – 10am – noon Eastern**
   1. Comment resolution
      1. CID 1201, 1203, 1204, 1205 – doc 11-22/659 – Kim (Ofinno)
      2. CID 1207 – doc 11-22/687 – Kim (Ofinno)
      3. CID 1011 – doc 11-22/115 – Patil (Qualcomm)
      4. CID 1000 – doc 11-22/535 – Patil (Qualcomm)
      5. CID 1018 – doc 11-22/276 – Patil (Qualcomm)
      6. SEC CIDs – Montemurro (Huawei)
2. **Friday June 3, 2022 – 10am – noon Eastern**
   1. Comment resolution
      1. CID 1024, 1113 – doc 11-22/528 – (Abdel) Ajami (Qualcomm)
      2. CID 2349 – doc 706 – Xin (Huawei)
      3. CID 2347 – doc 11-22/775 – Wang (Interdigital)
      4. CID 2345 – doc 11-22/707 – Wang (Interdigital)
      5. CIDs 2353, 2362, 2363 – doc 11-22/691 – Fang (Mediatek)
      6. MAC CIDs – Hamilton (Ruckus-Commscope)
3. **Monday June 6, 2022 – 10am – noon Eastern** 
   1. Comment resolution
      1. CIDs 1231, 2310 – doc 11-22/765 – McCann (Huawei)
      2. GEN CIDs – doc 11-22/839 – Montemurro (Huawei)
      3. GEN Review CIDs – Rosdahl (Qualcomm)
4. **Monday June 13, 2022 – 10am – noon Eastern** 
   1. Comment resolution
      1. CIDs – doc 11-22/1128 – Rison (Samsung)
      2. CIDs – doc 11-22/353 – Rison (Samsung)
5. **Friday June 17, 2022 – 10am – noon Eastern** 
   1. Comment resolution
      1. CIDs 1002, 1821, 1017, 1014, 1745, 1808, 1013, 1015, 1016 – doc 11-22/689 – Koundourakis (Samsung)
      2. MAC CIDs – Hamilton (Ruckus-Commscope)
6. **Monday June 20, 2022 – 10am – noon Eastern** 
   1. Comment resolution (priority to Security-related CIDs)
      1. CIDs 2382 and 2383 withdrawn
      2. No CID (SEC) – doc 11-22/399 – Huang (Intel) [10 min as requested]
      3. SEC CIDs – Montemurro (Huawei)
7. **Friday June 24, 2022 – 10am – noon Eastern** 
   1. Comment resolution
      1. CID 2315 (MAC) and CID 1210 (MAC) withdrawn
      2. MAC CIDs – Hamilton (Ruckus-Commscope)
8. **Monday June 27, 2022 – 10am – noon Eastern** 
   1. Motions
      1. Slides *x – y* of document 11-22/56
   2. Comment resolution
      1. CIDs 2386, 2387 – doc 11-22/719 – Asai (NTT)
      2. TDLS CIDs – doc 11-22/722 – Wentink (Qualcomm)
      3. SEC CIDs – Montemurro (Huawei)

5.       **AOB**

6. **Adjourn**

NOTES:

* For July:
  + TDLS CIDs – doc 11-22/722 – Wentink (Qualcomm)
  + ED2 CIDs – doc-11-22/876 – Au (Huawei)
  + CID 1469 – doc 22/680r2 – Halasz (Morse Micro)
  + CID 1490 – doc 22/644r2 – Halasz (Morse Micro)
  + CID 1011 – doc 11-22/115 – Patil (Qualcomm)
  + CID 2355, 2356 – doc 11-22/669 – Fang (Mediatek)
  + CID 2347 – doc 11-22/775 – Wang (InterDigital)
  + ED1 comments – doc 11-22/319r5 – Qi (Intel)
  + CID 2243, 2244, 2390, 2391 – doc 11-22/652 Lin (InterDigital)
  + CIDs – doc 11-22/353 – Rison (Samsung)
  + CIDs 1073, 2327, 2328, 2329 – doc 11-22/0838 – Handte (Sony)
  + CID 2022 – doc 11-22/522 – Naik (Qualcomm)
  + PHY and low-level CIDs – doc 11-22/576 – Hart (Cisco)
  + CID 2195 – doc 11-22/917 – Lee (Signify)
  + MAC CIDs – doc 11-22/xxxx – Smith (SR Technologies)
  + (TBD) CID 1024, 1113 – doc 11-22/528 – Patil (Qualcomm)
  + (TBD) CID 1808, 1013, 1015, 1016, 1819 – doc 11-22/82 – Patil (Qualcomm)
  + (TBD) CID 2319 – doc 11-22/658 – Das (Peraton Labs)
  + (TBD) CID 1220 – Coffey (Realtek)
  + (TBD) CIDs ~~2353~~, 2362, 2363 – doc 11-22/691 – Fang (Mediatek)
  + No CID – doc 11-22/911 – Chen (Zeku)
* Teleconferences are subject to applicable policies and procedures, see below.

==================================================see <https://mentor.ieee.org/802.11/dcn/22/11-22-0208-00-0000-2nd-vice-chair-report-march-2022.pptx>

**References:**